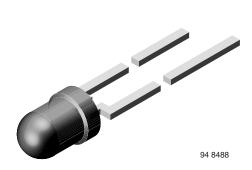


High Speed Infrared Emitting Diode, 940 nm, GaAlAs, MQW



DESCRIPTION

VSLB3948 is a high speed infrared emitting diode in GaAlAs, MQW technology, molded in a clear plastic package.

FEATURES

Package type: leaded

• Package form: T-1, clear epoxy

• Dimensions: Ø 3 mm

· High speed

High radiant power

· Low forward voltage

· Suitable for high pulse current operation

• Angle of half intensity: $\varphi = \pm 22^{\circ}$

• Peak wavelength: $\lambda_p = 940 \text{ nm}$

· Good spectral matching to Si photodetectors

 Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



FREE GREEN (5-2008)

APPLICATIONS

· Infrared remote control units

PRODUCT SUMMA	ARY			
COMPONENT	I _e (mW/sr)	φ (deg)	λ _p (nm)	t _r (ns)
VSLB3948	65	± 22	940	15

Note

· Test conditions see table "Basic Characteristics"

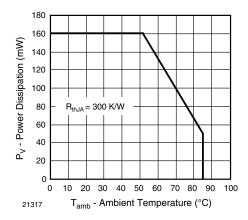
ORDERING INFORMATI	ON		
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
VSLB3948	Bulk	MOQ: 5000 pcs, 5000 pcs/bulk	T-1

Note

· MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V _R	5	V	
Forward current		I _F	100	mA	
Peak forward current	$t_p/T = 0.1$, $t_p = 100 \mu s$	I _{FM}	500	mA	
Surge forward current	t _p = 100 μs	I _{FSM}	1	Α	
Power dissipation		P _V	160	mW	
Junction temperature		Tj	100	°C	
Operating temperature range		T _{amb}	-25 to +85	°C	
Storage temperature range		T _{stg}	-40 to +100	°C	
Soldering temperature	t ≤ 5 s, 2 mm from case	T _{sd}	260	°C	
Thermal resistance junction/ambient	J-STD-051, leads 7 mm, soldered on PCB	R _{thJA}	300	K/W	







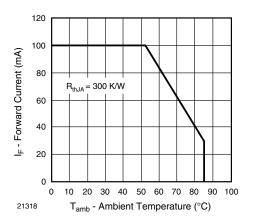


Fig. 2 - Forward Current Limit vs. Ambient Temperature

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	V _F	1.22	1.42	1.62	V
Temperature coefficient of V _F	I _F = 1 mA	TK _{VF}		-1.5		mV/K
Reverse current	V _R = 5 V	I _R			10	μΑ
Junction capacitance	$V_R = 0 \text{ V, f} = 1 \text{ MHz,}$ $E = 0 \text{ mW/cm}^2$	CJ		21		pF
Radiant intensity	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	l _e	32	65	110	mW/sr
Radiant power	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	фе		40		mW
Temperature coefficient of radiant power	I _F = 1 mA	TKφ _e		-1.1		%/K
	I _F = 100 mA	TKφ _e		-0.51		%/K
Angle of half intensity		φ		± 22		deg
Peak wavelength	$I_F = 30 \text{ mA}$	λ_{p}		940		nm
Spectral bandwidth	I _F = 30 mA	Δλ		30		nm
Temperature coefficient of Ip	I _F = 30 mA	$TK_{\lambda p}$		0.25		nm
Rise time	I _F = 100 mA, 20 % to 80 %	t _r		15		ns
Fall time	I _F = 100 mA, 20 % to 80 %	t _f		15		ns
Virtual source diameter		d		2		mm

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

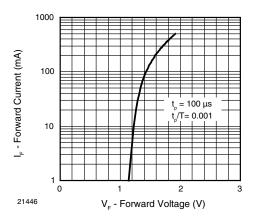


Fig. 3 - Forward Current vs. Forward Voltage

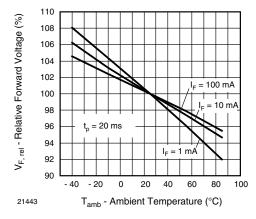


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

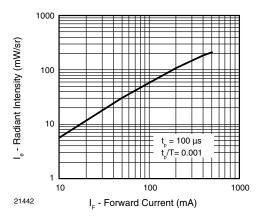


Fig. 5 - Radiant Intensity vs. Forward Current

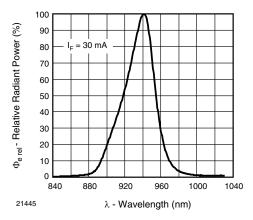


Fig. 6 - Relative Radiant Power vs. Wavelength

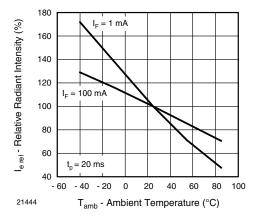


Fig. 7 - Relative Radiant Intensity vs. Ambient Temperature

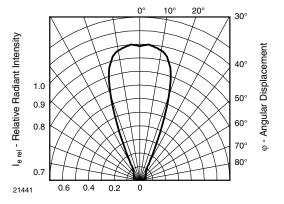
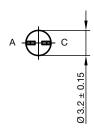
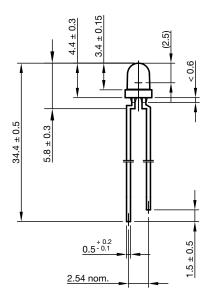


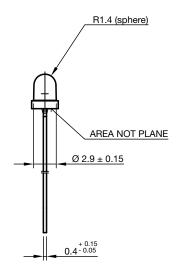
Fig. 8 - Relative Radiant Intensity vs. Angular Displacement



PACKAGE DIMENSIONS in millimeters







technical drawings according to DIN specifications

Drawing-No.: 6.544-5255.01-4

Issue: 9; 28.07.14



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